INFORMATION DISCLOSURE STATEMENT Atty. Docket No.: 150.0072 0103

Serial No.: Filed herewith

Applicant(s): Cobbley et al.

Confirmation No.:

Group:

		S. PATENT	DOCUMENTS Name	Class	Subclass	Filing Date If
Examiner Initial	Document Number	Date	Name	Class	Subciass	Appropriate
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FRL WAS	11/15/02
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(1993).

Atty. Docket No.: 150.0072 0103	Serial No.: Filed herewith
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DV)	5,945,733	08/31/99	Corbett et al.				
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SUPPLEMENTAL INFORMATION DISCLOSURE 61819 TEMENT

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·Atty. Docket No.: 150.00720103	Serial No.: 09/941,495
Applicant(s): Cobbley et al.	Confirmation No.: 7146
Application Filing Date: 29 August 2001	Group: 2822
Supplemental Information Disclosure Statement mailed:	September 10 2002

I DISCLOSURE			Applican	int(s). Coooley et al.			Confirmation No.: 7140					
Application Filing Date: 29 August 2001				Group: 2822								
Statement mail							eptember 10 2002				O.C.	
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Examiner Initial	Copy Enclosed	Document Number		Date	Name	Clas	Class		Subclass Filing Date If Appropriate		ኢ	
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Examiner	Сору	Document Number	Date	Country	Class	Subclass	Trans	lation
Initial	Enclosed				l		Yes	No
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